

SID

Factory: Rot am See

Article:

527

ML6

Provided:

Kracht, Enrico

Customer:

Date:

10.08.2015



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	μm	Stackup	Process overview
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A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	295		2	
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		3	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		4	
C-RS-FR4-ML-0.36mm-070+070-TG150-HF	50200997	70	L2		A01
		360		5	
		70	L3		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	260		6	B00
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		7	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		8	
C-RS-FR4-ML-0.36mm-070+070-TG150-HF	50200997	70	L4		A02
		360		9	
		70	L5		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	295		10	
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		11	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		12	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	13	

Thickness after Pressing

B00:

1890 μm

Tol+:

200 μm

Tol-:

200 μm

Dmax:

2090 μm

Dmin:

1690 μm

Thickness over all

0 μm

Tol+:

0 μm

Tol-:

0 μm

Dmax:

0 μm

Dmin:

0 μm

Demand for customer

Thickness (D):

2000 μm

Tol+:

200 μm

Tol-:

200 μm

Dmax:

2200 μm

Dmin:

1800 μm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

1886 μm

Version 1.2.14.15

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